

## General Description

The GreenMOS<sup>®</sup> high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS<sup>®</sup> Z series is integrated with fast recovery diode (FRD) to minimize reverse recovery time. It is suitable for resonant switching topologies to reach higher efficiency, higher reliability and smaller form factor.

## Features

- Low  $R_{DS(ON)}$  & FOM
- Extremely low switching loss
- Excellent stability and uniformity




## Applications

- LED lighting
- Telecom
- Adapter
- Sever
- Solar/UPS

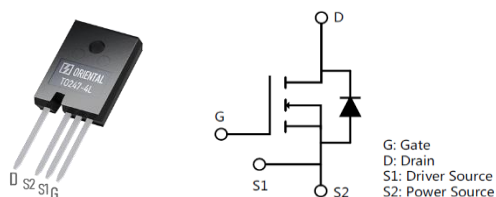
## Key Performance Parameters

| Parameter                         | Value | Unit       |
|-----------------------------------|-------|------------|
| $V_{DS}$                          | 650   | V          |
| $I_D$ , pulse                     | 186   | A          |
| $R_{DS(ON)}$ , max @ $V_{GS}=10V$ | 40    | m $\Omega$ |
| $Q_g$                             | 107   | nC         |
| PD                                | 360   | W          |

## Marking Information

| Product Name    | Package  | Marking        |
|-----------------|----------|----------------|
| OSG65R040H4T4ZF | TO247-4L | OSG65R040H4T4Z |

## Package & Pin Information



**Absolute Maximum Ratings** at  $T_j=25^{\circ}\text{C}$  unless otherwise noted

| Parameter                                                                 | Symbol                 | Value      | Unit               |
|---------------------------------------------------------------------------|------------------------|------------|--------------------|
| Drain-source voltage                                                      | $V_{DS}$               | 650        | V                  |
| Gate-source voltage (static)                                              | $V_{GS}$               | $\pm 20$   | V                  |
| Gate-source voltage (dynamic)                                             |                        | $\pm 30$   | V                  |
| Continuous drain current <sup>1)</sup> , $T_C=25^{\circ}\text{C}$         | $I_D$                  | 62         | A                  |
| Continuous drain current <sup>1)</sup> , $T_C=100^{\circ}\text{C}$        |                        | 39.2       |                    |
| Pulsed drain current <sup>2)</sup> , $T_C=25^{\circ}\text{C}$             | $I_{D, \text{ pulse}}$ | 186        | A                  |
| Continuous diode forward current <sup>1)</sup> , $T_C=25^{\circ}\text{C}$ | $I_S$                  | 62         | A                  |
| Diode pulsed current <sup>2)</sup> , $T_C=25^{\circ}\text{C}$             | $I_{S, \text{ pulse}}$ | 186        | A                  |
| Power dissipation <sup>3)</sup> , $T_C=25^{\circ}\text{C}$                | $P_D$                  | 360        | W                  |
| Single pulsed avalanche energy <sup>4)</sup>                              | $E_{AS}$               | 518        | mJ                 |
| MOSFET dv/dt ruggedness, $V_{DS}=0\ldots 400\text{ V}$                    | dv/dt                  | 100        | V/ns               |
| Reverse diode dv/dt, $V_{DS}=0\ldots 400\text{ V}$ , $I_{SD}\leq I_D$     | dv/dt                  | 50         | V/ns               |
| Operation and storage temperature                                         | $T_{stg}, T_j$         | -55 to 150 | $^{\circ}\text{C}$ |

**Thermal Characteristics**

| Parameter                            | Symbol          | Value | Unit                 |
|--------------------------------------|-----------------|-------|----------------------|
| Thermal resistance, junction-case    | $R_{\theta JC}$ | 0.35  | $^{\circ}\text{C/W}$ |
| Thermal resistance, junction-ambient | $R_{\theta JA}$ | 62    | $^{\circ}\text{C/W}$ |

**Electrical Characteristics** at  $T_j=25^{\circ}\text{C}$  unless otherwise specified

| Parameter                        | Symbol       | Min. | Typ. | Max. | Unit          | Test condition                                                       |
|----------------------------------|--------------|------|------|------|---------------|----------------------------------------------------------------------|
| Drain-source breakdown voltage   | $BV_{DSS}$   | 650  |      |      | V             | $V_{GS}=0\text{ V}$ , $I_D=2\text{ mA}$                              |
| Gate threshold voltage           | $V_{GS(th)}$ | 3.5  |      | 5.5  | V             | $V_{DS}=V_{GS}$ , $I_D=2\text{ mA}$                                  |
| Drain-source on-state resistance | $R_{DS(ON)}$ |      | 33   | 40   | m $\Omega$    | $V_{GS}=10\text{ V}$ , $I_D=32\text{ A}$                             |
|                                  |              |      | 79   |      |               | $V_{GS}=10\text{ V}$ , $I_D=32\text{ A}$ , $T_j=150^{\circ}\text{C}$ |
| Gate-source leakage current      | $I_{GSS}$    |      |      | 100  | nA            | $V_{GS}=20\text{ V}$                                                 |
|                                  |              |      |      | -100 |               | $V_{GS}=-20\text{ V}$                                                |
| Drain-source leakage current     | $I_{DSS}$    |      |      | 10   | $\mu\text{A}$ | $V_{DS}=650\text{ V}$ , $V_{GS}=0\text{ V}$                          |
| Gate resistance                  | $R_G$        |      | 2.8  |      | $\Omega$      | $f=1\text{ MHz}$ , Open drain                                        |

### Dynamic Characteristics

| Parameter                                    | Symbol       | Min. | Typ. | Max. | Unit | Test condition                                                                              |
|----------------------------------------------|--------------|------|------|------|------|---------------------------------------------------------------------------------------------|
| Input capacitance                            | $C_{iss}$    |      | 5307 |      | pF   | $V_{GS}=0\text{ V}$ ,<br>$V_{DS}=50\text{ V}$ ,<br>$f=100\text{ kHz}$                       |
| Output capacitance                           | $C_{oss}$    |      | 267  |      | pF   |                                                                                             |
| Reverse transfer capacitance                 | $C_{rss}$    |      | 4.2  |      | pF   |                                                                                             |
| Effective output capacitance, energy related | $C_{o(er)}$  |      | 180  |      | pF   | $V_{GS}=0\text{ V}$ ,<br>$V_{DS}=0\text{ V}-400\text{ V}$                                   |
| Effective output capacitance, time related   | $C_{o(tr)}$  |      | 1200 |      | pF   |                                                                                             |
| Turn-on delay time                           | $t_{d(on)}$  |      | 37   |      | ns   | $V_{GS}=10\text{ V}$ ,<br>$V_{DS}=400\text{ V}$ ,<br>$R_G=2\ \Omega$ ,<br>$I_D=32\text{ A}$ |
| Rise time                                    | $t_r$        |      | 12   |      | ns   |                                                                                             |
| Turn-off delay time                          | $t_{d(off)}$ |      | 72   |      | ns   |                                                                                             |
| Fall time                                    | $t_f$        |      | 2.4  |      | ns   |                                                                                             |

### Gate Charge Characteristics

| Parameter            | Symbol        | Min. | Typ. | Max. | Unit | Test condition                                                         |
|----------------------|---------------|------|------|------|------|------------------------------------------------------------------------|
| Total gate charge    | $Q_g$         |      | 107  |      | nC   | $V_{GS}=10\text{ V}$ ,<br>$V_{DS}=400\text{ V}$ ,<br>$I_D=32\text{ A}$ |
| Gate-source charge   | $Q_{gs}$      |      | 34   |      | nC   |                                                                        |
| Gate-drain charge    | $Q_{gd}$      |      | 46   |      | nC   |                                                                        |
| Gate plateau voltage | $V_{plateau}$ |      | 7.2  |      | V    |                                                                        |

### Body Diode Characteristics

| Parameter                     | Symbol    | Min. | Typ. | Max. | Unit          | Test condition                                                                  |
|-------------------------------|-----------|------|------|------|---------------|---------------------------------------------------------------------------------|
| Diode forward voltage         | $V_{SD}$  |      |      | 1.3  | V             | $I_S=62\text{ A}$ ,<br>$V_{GS}=0\text{ V}$                                      |
| Reverse recovery time         | $t_{rr}$  |      | 176  |      | ns            | $V_R=400\text{ V}$ ,<br>$I_S=32\text{ A}$ ,<br>$di/dt=100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge       | $Q_{rr}$  |      | 1.1  |      | $\mu\text{C}$ |                                                                                 |
| Peak reverse recovery current | $I_{rrm}$ |      | 10.4 |      | A             |                                                                                 |

### Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4)  $V_{DD}=100\text{ V}$ ,  $V_{GS}=10\text{ V}$ ,  $L=75\text{ mH}$ , starting  $T_j=25\text{ }^\circ\text{C}$ .

## Electrical Characteristics Diagrams

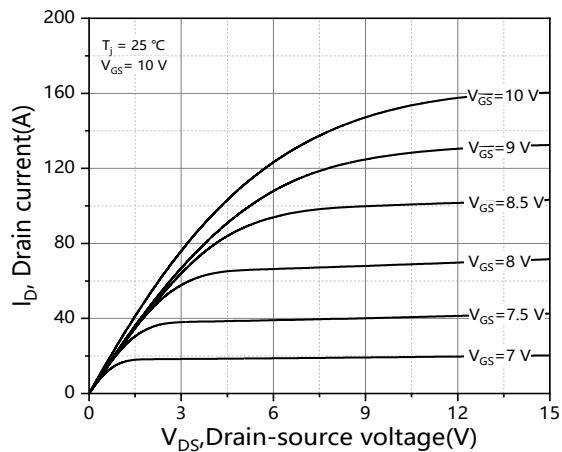


Figure 1. Typ. output characteristics  $T_J=25^{\circ}\text{C}$

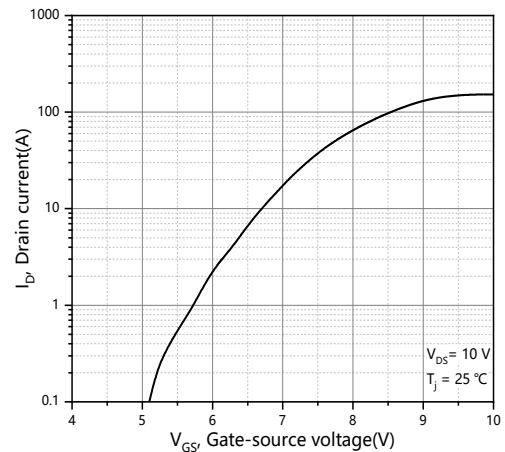


Figure 2. Typ. transfer characteristics

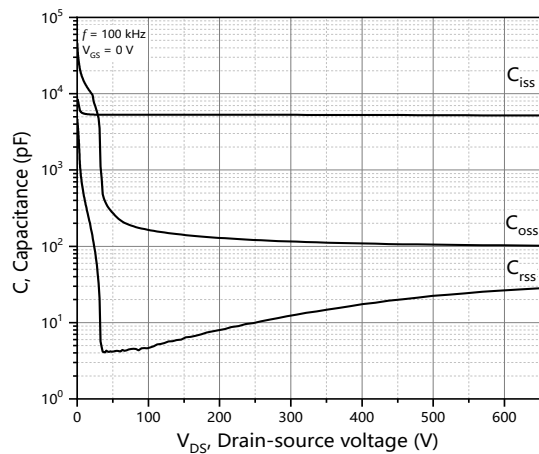


Figure 3. Typ. capacitances

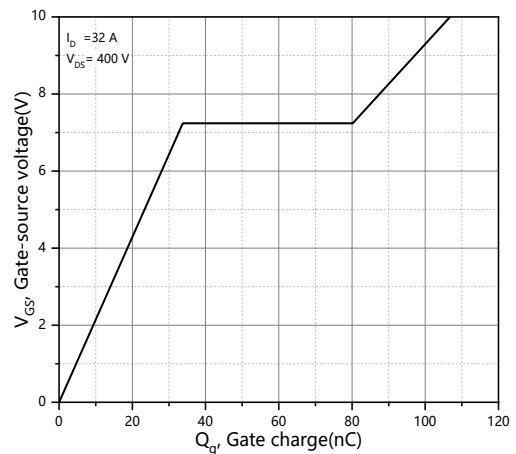


Figure 4. Typ. gate charge

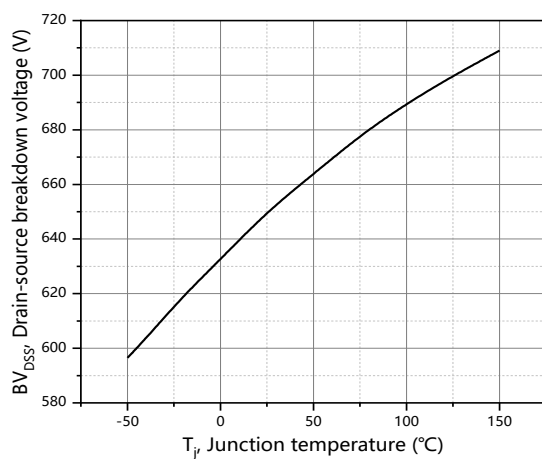


Figure 5. Drain-source breakdown voltage

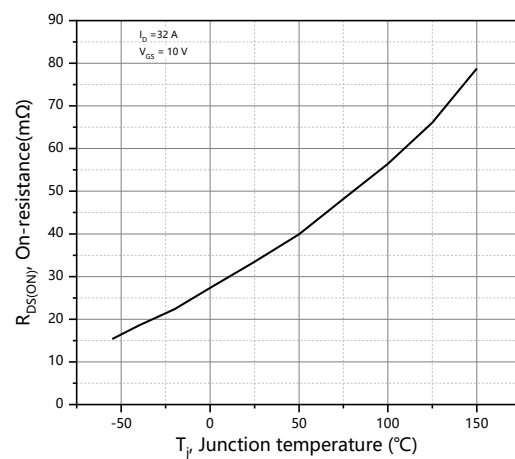
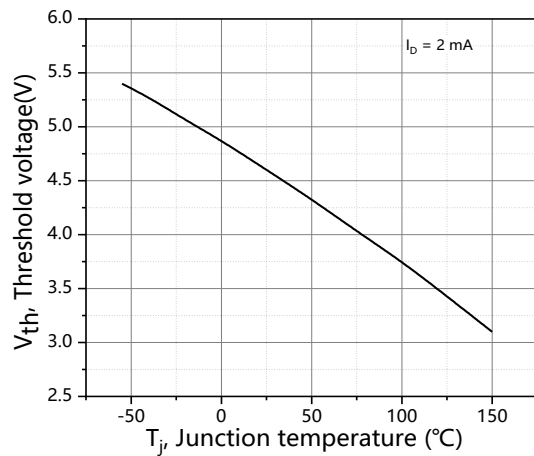
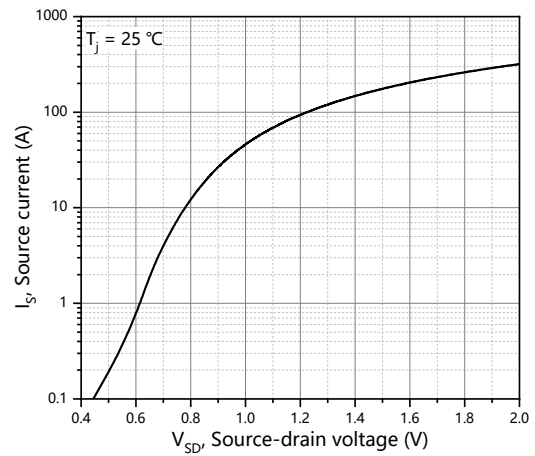


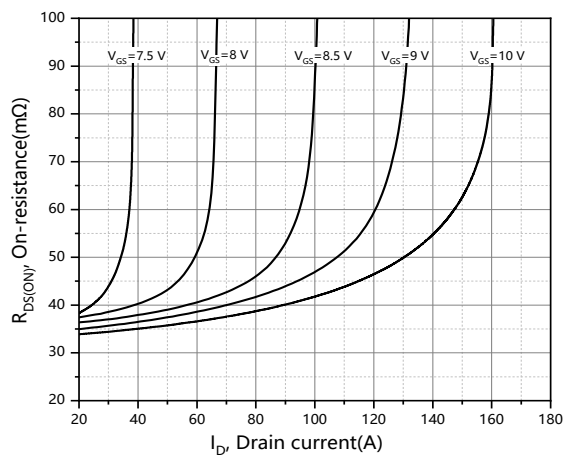
Figure 6. Drain-source on-state resistance



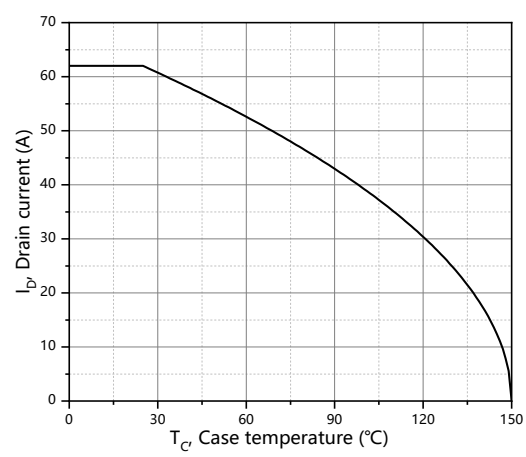
**Figure 7. Threshold voltage**



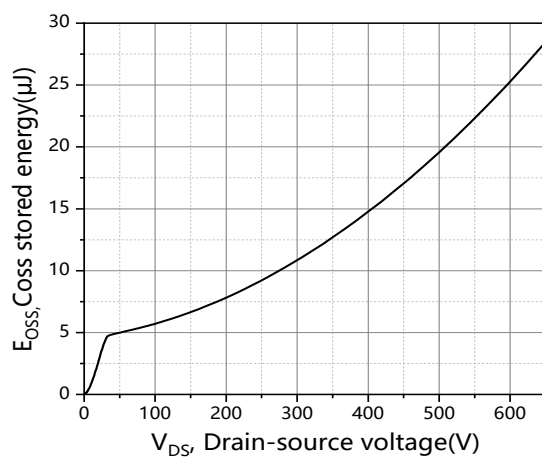
**Figure 8. Forward characteristic of body diode**



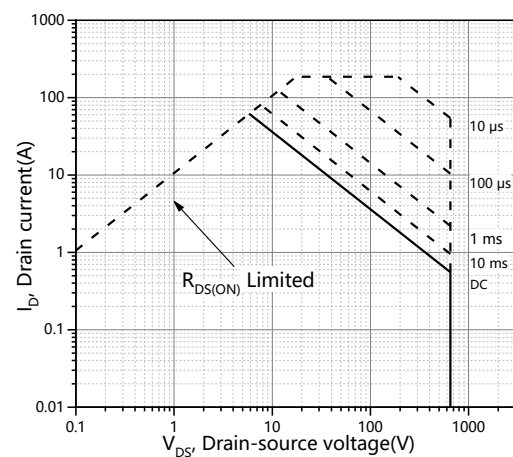
**Figure 9. Drain-source on-state resistance**



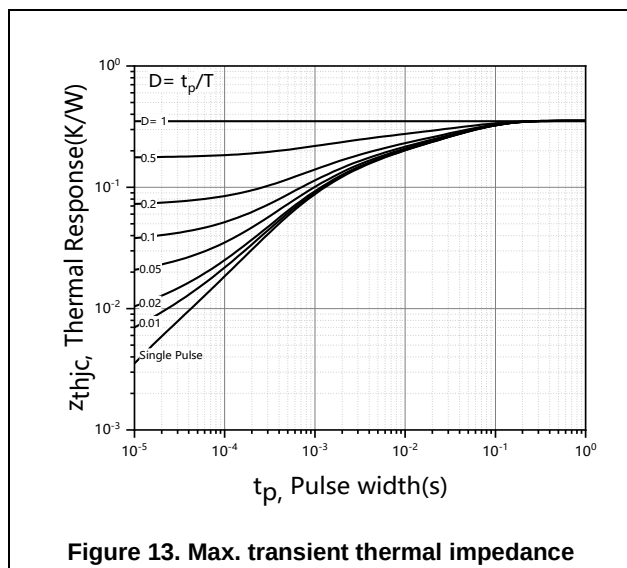
**Figure 10. Drain current**



**Figure 11. Typ. Coss stored energy**

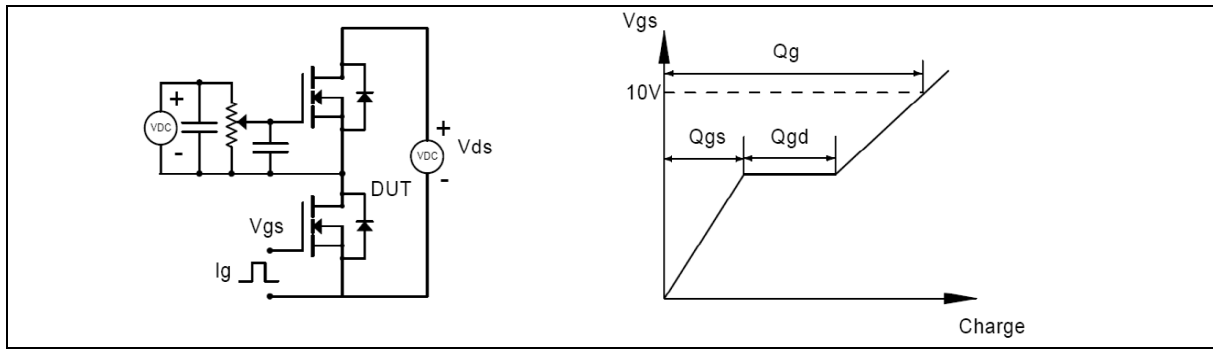


**Figure 12. Safe operation area  $T_c=25^\circ\text{C}$**

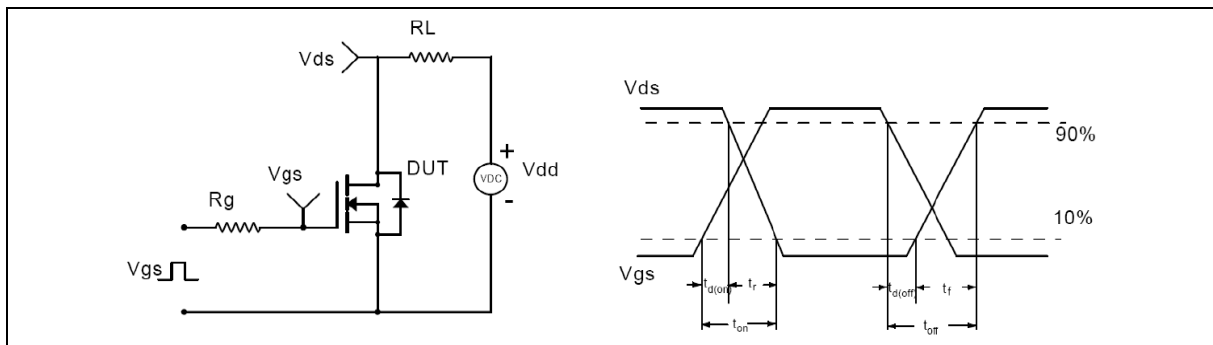


**Figure 13. Max. transient thermal impedance**

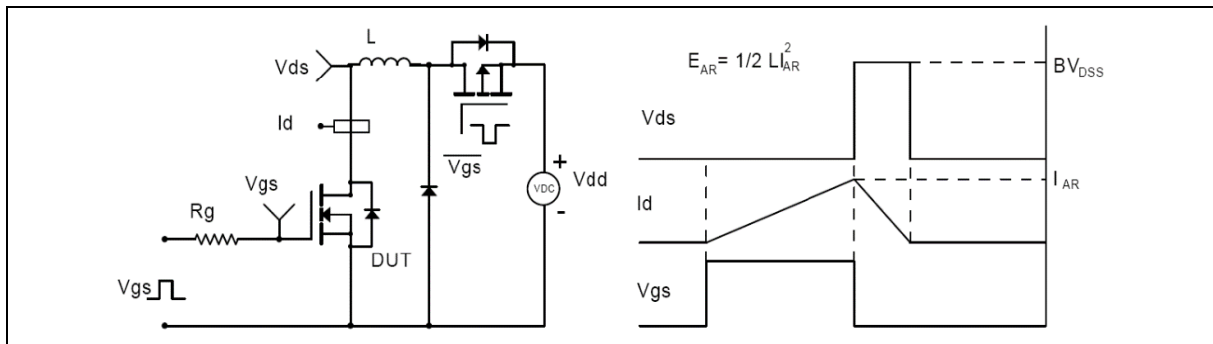
## Test circuits and waveforms



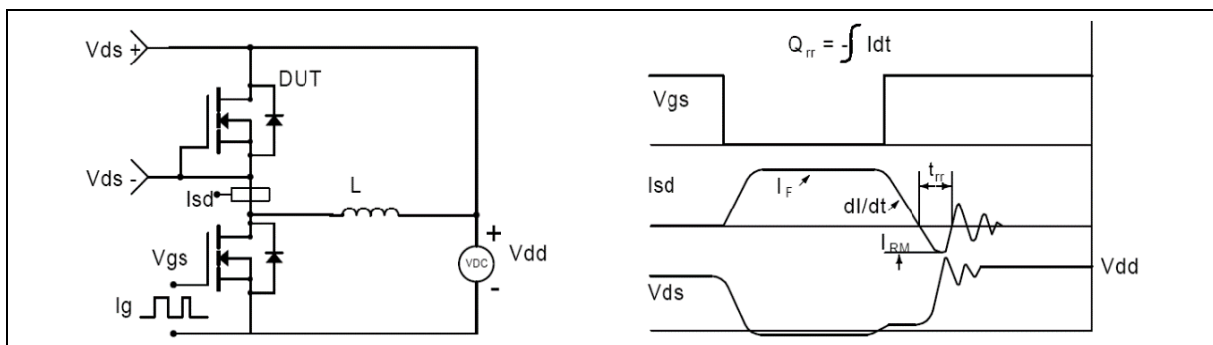
**Figure 1. Gate charge test circuit & waveform**



**Figure 2. Switching time test circuit & waveforms**

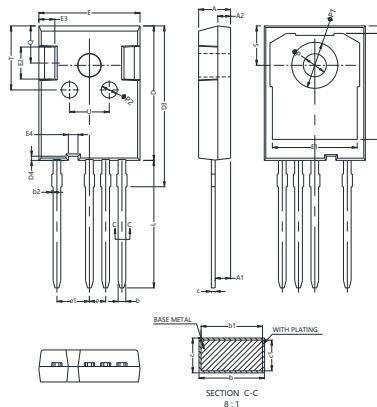


**Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms**



**Figure 4. Diode reverse recovery test circuit & waveforms**

## Package Information



| Symbol | mm      |       |       |
|--------|---------|-------|-------|
|        | Min     | Nom   | Max   |
| A      | 4.90    | 5.00  | 5.10  |
| A1     | 2.31    | 2.41  | 2.51  |
| A2     | 1.90    | 2.00  | 2.10  |
| b      | 1.16    |       | 1.29  |
| b1     | 1.15    | 1.2   | 1.25  |
| b2     | 0.00    |       | 0.20  |
| c      | 0.59    |       | 0.66  |
| c1     | 0.58    | 0.60  | 0.62  |
| D      | 20.90   | 21.00 | 21.10 |
| D1     | 16.25   | 16.55 | 16.85 |
| D2     | 1.05    | 1.20  | 1.35  |
| D3     | 24.97   | 25.12 | 25.27 |
| D4     | 0.55    | 0.65  | 0.75  |
| E      | 15.70   | 15.80 | 15.90 |
| E1     | 13.10   | 13.30 | 13.50 |
| E2     | 4.90    | 5.00  | 5.10  |
| E3     | 2.40    | 2.50  | 2.60  |
| E4     | 1.40    | 1.50  | 1.60  |
| e      | 2.44    | 2.54  | 2.64  |
| e1     | 4.98    | 5.08  | 5.18  |
| L      | 19.80   | 19.92 | 20.10 |
| P      | 3.50    | 3.60  | 3.70  |
| P1     |         |       | 7.40  |
| P2     | 2.40    | 2.50  | 2.60  |
| Q      | 5.60    |       | 6.00  |
| S      | 6.15BSC |       |       |
| T      | 9.80    |       | 10.20 |
| U      | 6.00    |       | 6.40  |

Version: TO247-4L-J package outline dimension



### Ordering Information

| Package Type | Units/ Tube | Tubes/ Inner Box | Units/ Inner Box | Inner Boxes/ Carton Box | Units/ Carton Box |
|--------------|-------------|------------------|------------------|-------------------------|-------------------|
| TO247-4L-J   | 30          | 20               | 600              | 4                       | 2400              |

### Product Information

| Product         | Package  | Pb Free | RoHS | Halogen Free |
|-----------------|----------|---------|------|--------------|
| OSG65R040H4T4ZF | TO247-4L | yes     | yes  | yes          |

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**Revision History**

| Version | Revision History | Date       |
|---------|------------------|------------|
| V1.0    | Initial release  | 2025-07-17 |